ACKNOWLEDGEMENT RECEIPT

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Title of Invention

Molded Stiffener for Thin Substrates

Submision Type:

Information Disclosure

Statement

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Doc. Name File Name ize (Bytes) Produced (yyyymmdd) MTI-31591-usidst.xml 1206 2005-07-22 us-ids.dtd 7763 2005-07-22 12026 2005-07-22 us-ids.xsl package-data MTI-31591-pkda.xml 1734 2005-07-22 oackage-data package-data.dtd 27025 2005-07-22 19263 2005-07-22 oackage-data us-package-data.xsl Total files size 69017

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